



# Molecular Friction Dissipation and Mode Coupling in Organic Monolayers and Polymer Films



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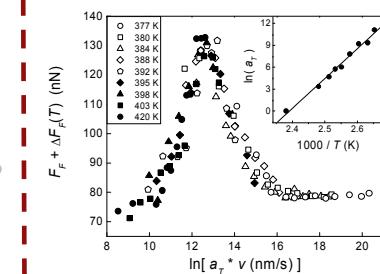
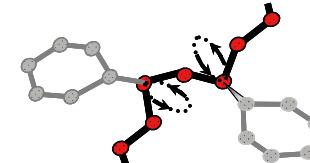
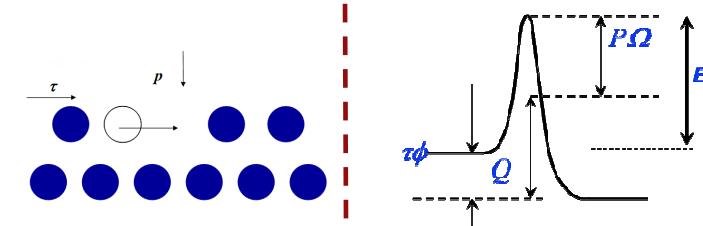
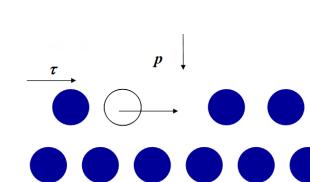
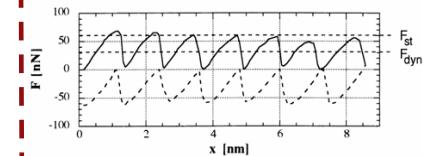
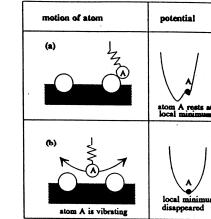
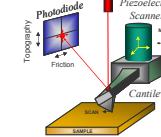


[roverney@u.washington.edu](mailto:roverney@u.washington.edu)  
<http://depts.washington.edu/nanolab/>

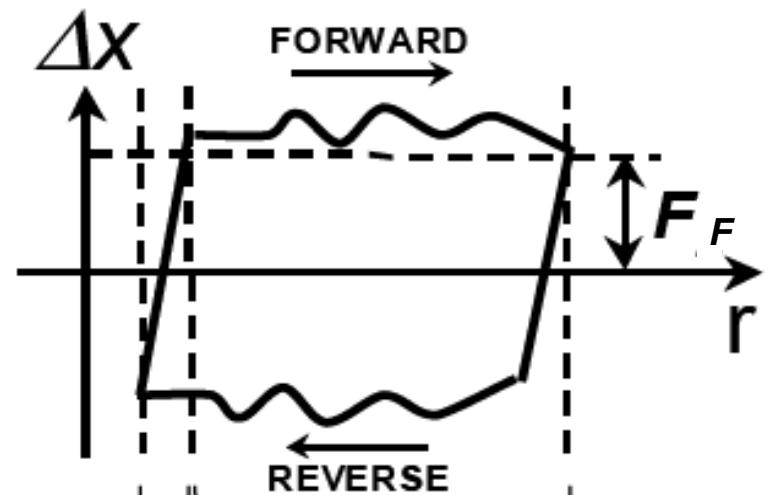
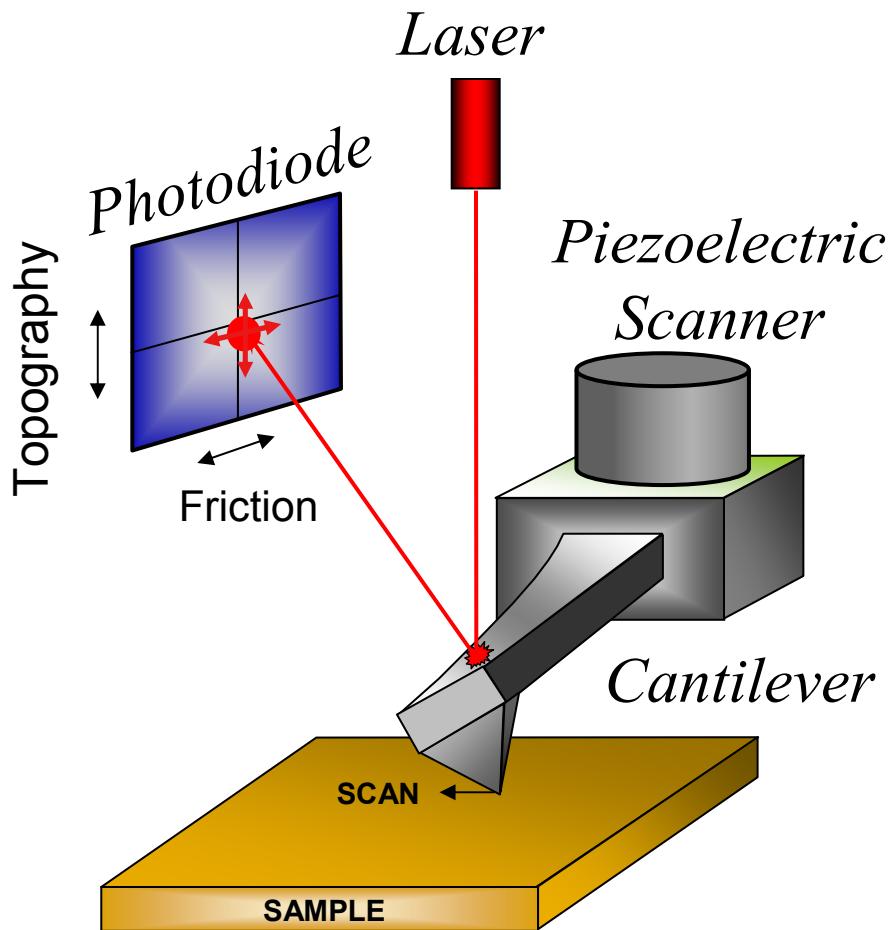


# Content

- Process Descriptive Analysis of Friction  
→ Stick Slip
- Friction as a Simple Activated Process  
→ Eyring Analysis
- Friction and Thermal Mode Coupling (Material specific energy)  
→ Time Temperature Superposition Analysis



# Lateral Force Microscopy



# Nanoscale Friction on Crystalline Surfaces



## Molecular Stick-Slip Model

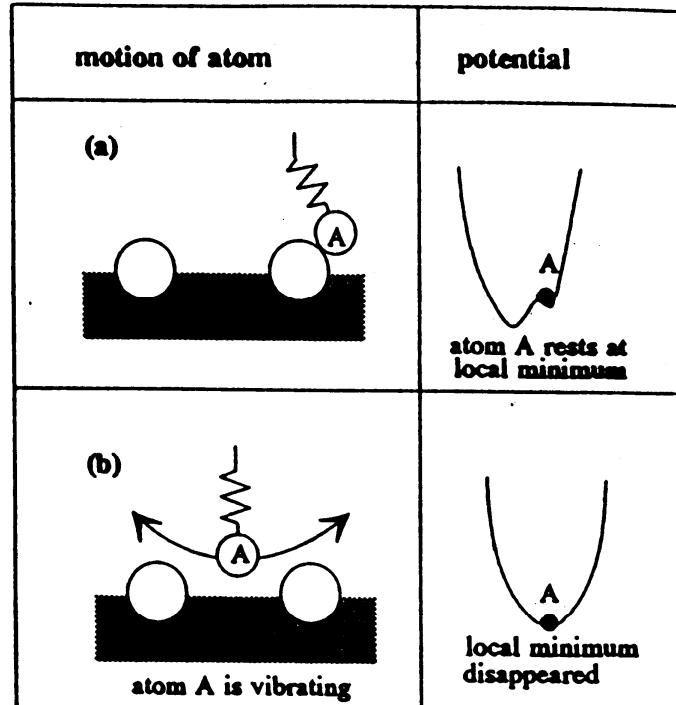
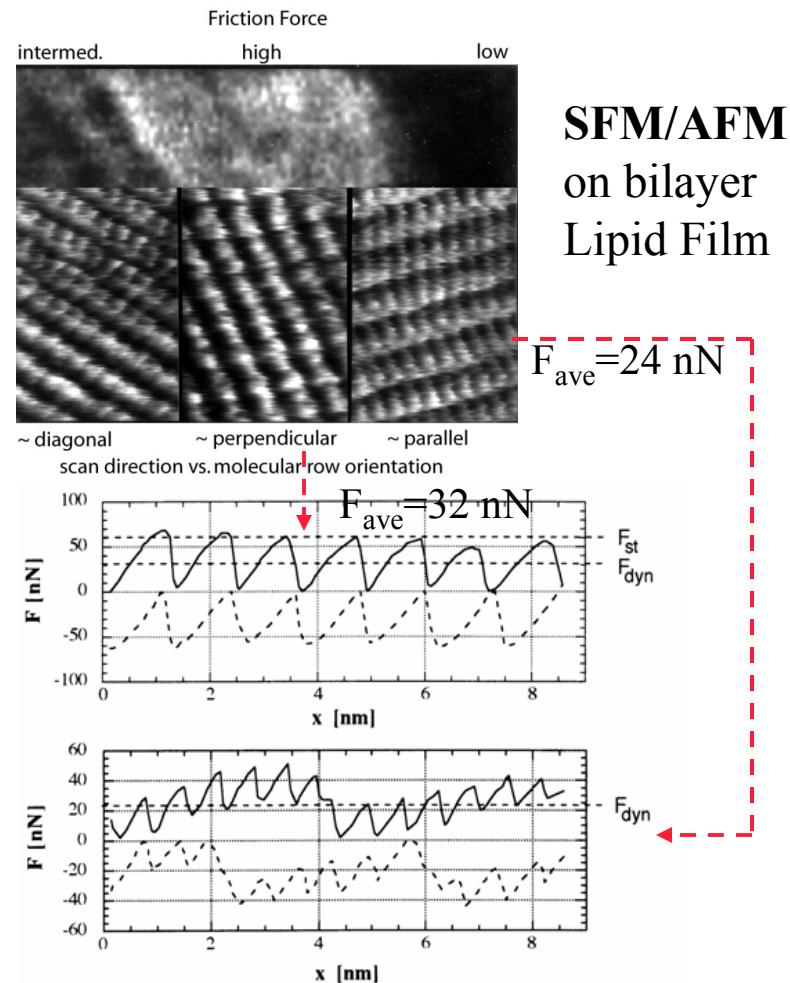


Fig. 1.15: Motion in the independent oscillator model.

Prandtl- Tomlinson  
Model

→ observed single molecular jump occurrences below 100 nm/s, and stochastic multiple jump occurrences above 800 nm/s

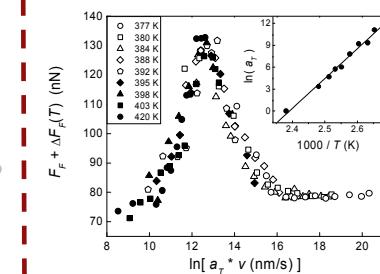
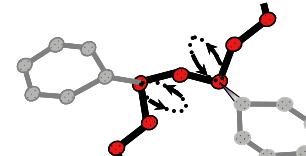
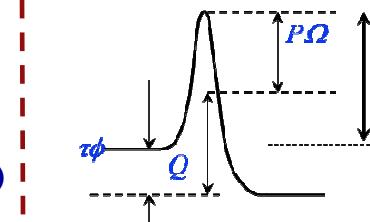
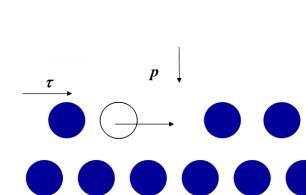
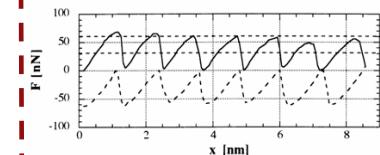
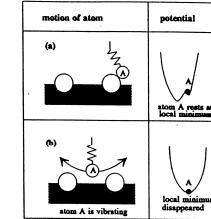
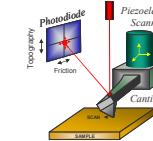


R. M. Overney et al., Phys. Rev. Lett.  
72, 3546 (1994)



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# The Eyring Model

“Reaction” rates:

$$k_v \propto \exp\left(-\frac{Q}{kT}\right); Q \dots \text{intrinsic barrier}$$

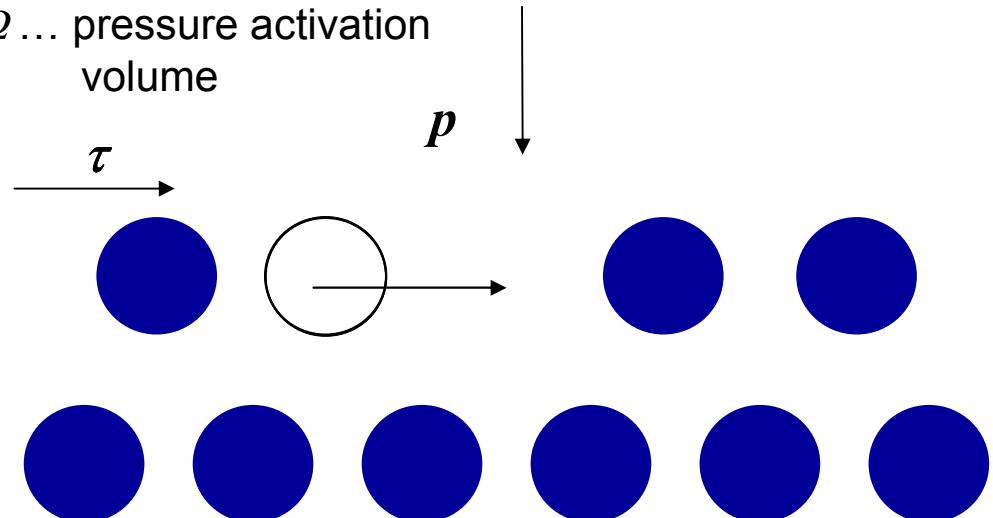
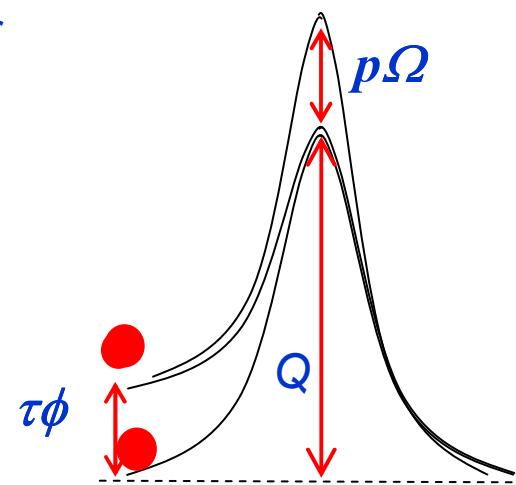
$$k_v \propto \exp\left(-\frac{Q + \phi\tau}{kT}\right); \tau \dots \text{shear stress}$$

$\phi \dots \text{stress activation volume}$

$$k_v \propto \exp\left(-\frac{Q - p\Omega + \phi\tau}{kT}\right); p \dots \text{pressure}$$

$\Omega \dots \text{pressure activation volume}$

Effective Energy Barrier:



Eyring, *J. Chem. Phys.* **3**, 107, (1935).

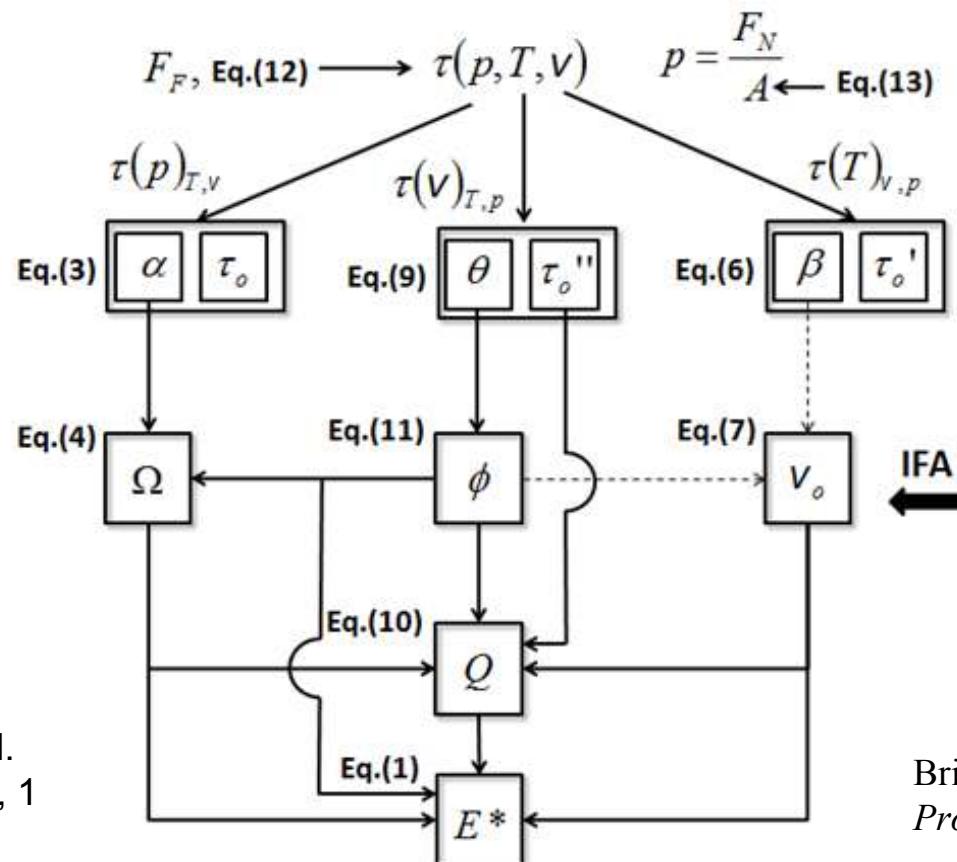
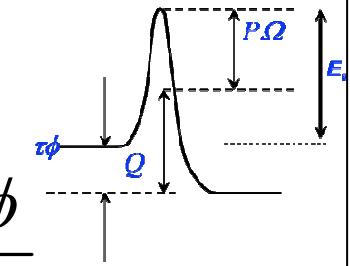
Eyring, *J. Chem. Phys.* **4**, 283, (1936).

Duckett, Rabinowitz, and Ward, *J. Mat. Sci.* **5**, 909 (1970).

# The Eyring Model: Friction (in high stress limit)

$$\left. \begin{aligned} v &= v_o \exp\left(\frac{-E_a}{kT}\right) \\ E_a &= Q + p\Omega - \tau\phi \end{aligned} \right\} \quad \ln\left(\frac{v}{v_0}\right) = \frac{-Q}{kT} - \frac{p\Omega}{kT} + \frac{\tau\phi}{kT}$$

$v$  = velocity;  $v_o$  = system specific velocity



$$\begin{aligned} \tau &= \theta \ln v + \tau_o'' \\ \tau &= \alpha p + \tau_o' \\ \tau &= -\beta T + \tau_o''' \\ \phi &= \frac{kT}{\theta} \\ \Omega &= \alpha \phi \end{aligned}$$

Knorr, Overney et al.  
J. Chem. Phys. **134**, 1  
04502 (2011)

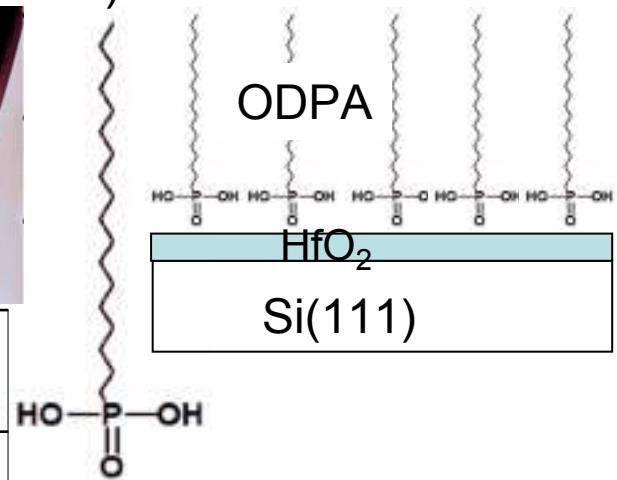
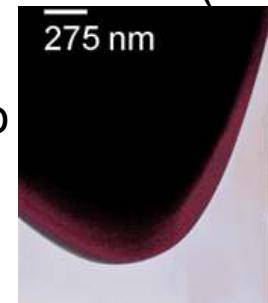
Briscoe and Evans,  
Proc. R. Soc. A. **380**, 389 (1982).

# Eyring Analysis of ODPA and ODTSt

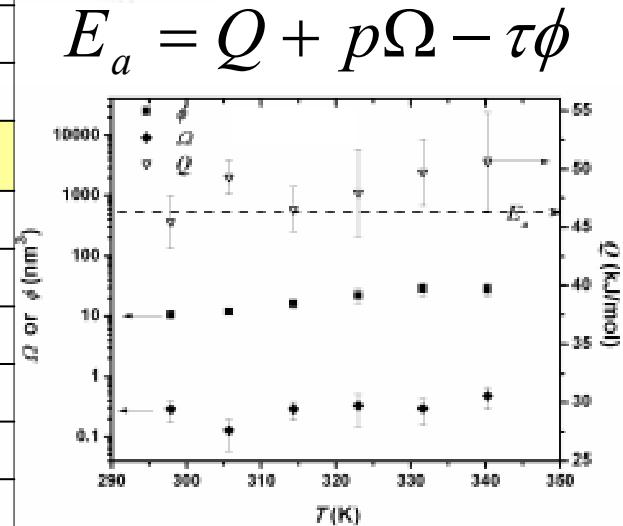
**Material:** C<sub>18</sub> Monolayer of octadecyl-phosphonic acid (ODPA) reacted via surface hydroxyls on HfO<sub>2</sub>, supported by Si(100).

**Analysis:** Using smooth SFM tips with up to 400 nm tip radii.

† K. Subhalakshmi, S. K. Biswas et al., Trib. Lett., **32**, 1 (2008)



Eyring Parameters	ODPA (R ~20 nm)	ODPA (R ~400 nm)	ODTS † (R~30nm)
T, K	297	297	295
L, nN	41.9	240	46.5
A ( $\times 10^{-16}$ ) m <sup>2</sup>	2.33	192	5.22
p, MPa	180	13	89
$\alpha$ (at 1 μm/s)	0.018	0.020	0.042
$\phi$ , nm <sup>3</sup>	2.10	13.06	4.69
$\Omega$ , nm <sup>3</sup> (at 1 μm/s)	0.037	0.255	0.1972
$\zeta = \phi/\Omega$	56±6	51±6	24
$\tau\phi$ , kJ/mol	3.5	5.0	14.5395
$p\Omega$ , kJ/mol	2.8	1.9	10.5824
$Q$ , kJ/mol (eV)	46.3 (0.48)	48.3 (0.50)	45.05 (0.47)
$E^*$ , kJ/mol (eV)	46±6 (0.47±0.06)	45±5 (0.47±0.05)	41.09 (0.43)



Knorr, Overney et al.  
J. Chem. Phys. **134**, 104502  
(2011)

# Eyring Analysis of PtBA

**Material:** Poly(tert-butyl acrylate) (PtBA) MW 100k, 200 nm thick spin coated film on Si(111)

**Analysis:** Using smooth SFM tips with up to 400 nm tip radii.

Eyring Parameters	PtBA ( $T = 315 \text{ K} < T_g$ )	ODPA ( $T = 297 \text{ K}$ )
$E^*$ , kJ/mol (eV)	$30 \pm 3$ (0.31)	$46 \pm 6$ ( $0.47 \pm 0.06$ )
$Q$ , kJ/mol (eV)	35-43 (0.36-0.45)	46-48 (0.48-0.50)
$\zeta = \phi / \Omega$	7.8	51-56
$v_o$ , m/s	$\sim 0.1$	$\sim 100$

$\zeta$  ... dimensionless deformation ratio

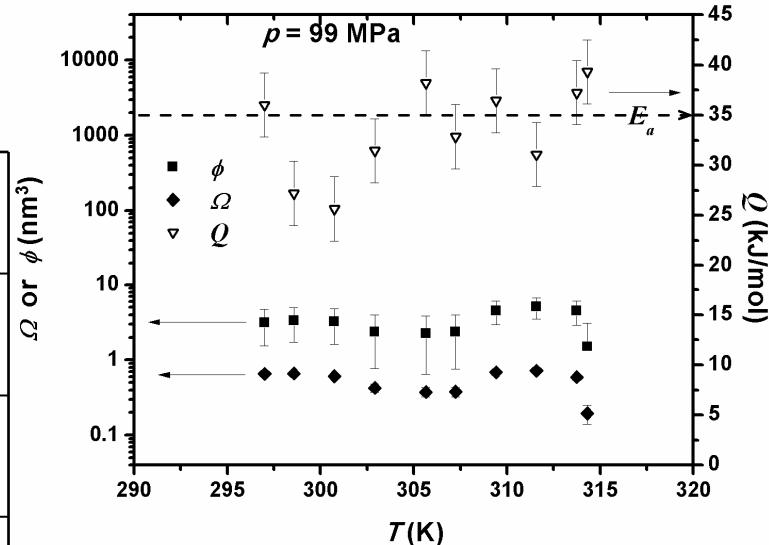
$v_o$  ... system/process characteristic velocity

Based on Eyring's Cage Model:

$$v_o = Cv b \quad \left\{ \begin{array}{l} C \dots \text{coupling constant } [0, 1] \\ v \dots \text{jump attempt frequency} \\ b \dots \text{jump } \{\text{barrier}\} \text{distance} \end{array} \right.$$

$b < 1.5 \text{ nm}$  based on IFA for PtBA ( $T < T_g$ )

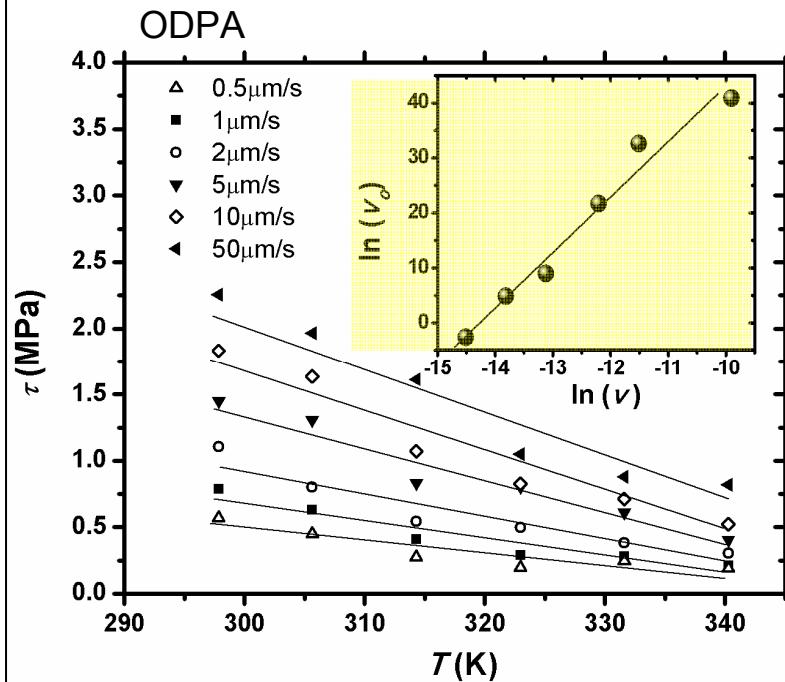
Knorr, Overney et al., J. Chem. Phys. **134**, 104502 (2011)



$$E_a = Q + p\Omega - \tau\phi$$

$v_o$  reflects the system's molecular ability to relax via the "jump velocity"  $v_b$ . as  $Q = f(v_o)$ ,  $v_o$  is critical.

# Eyring Analysis: $v_o$

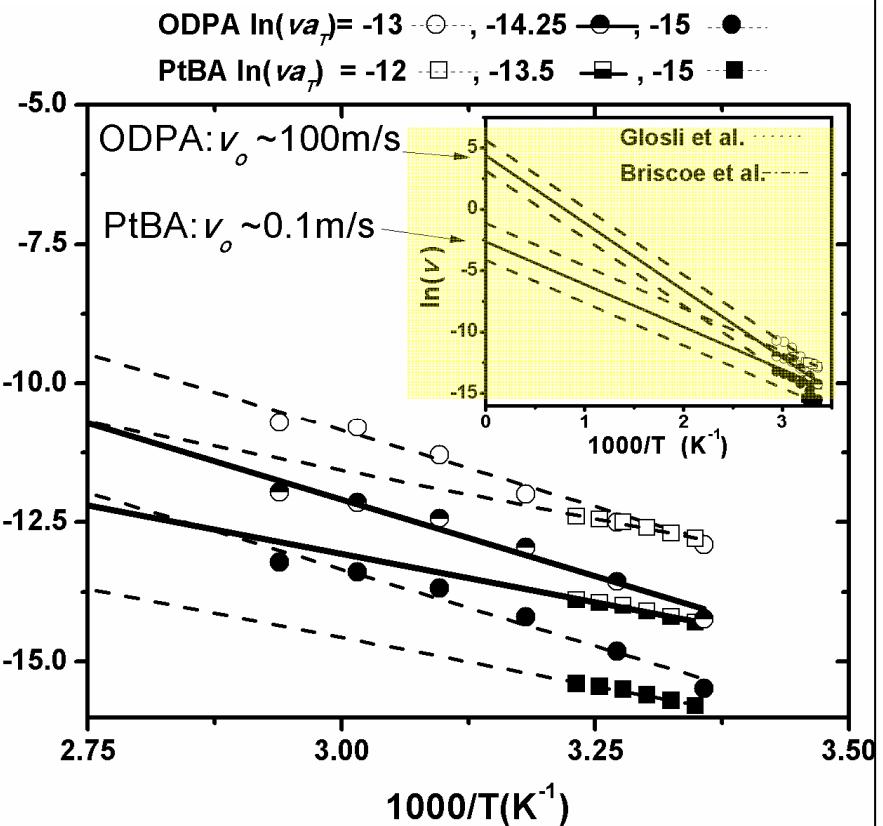


Using the Eyring Analysis, i.e.,

$$\tau = \tau''_o + \theta \ln \nu; \quad \tau''_o = \frac{Q + p\Omega - kT \ln v_o}{\phi}$$

→ large spread in  $v_o$  (to part unphysical)

$$v_o \in [10^{-2} - 10^{17}]$$



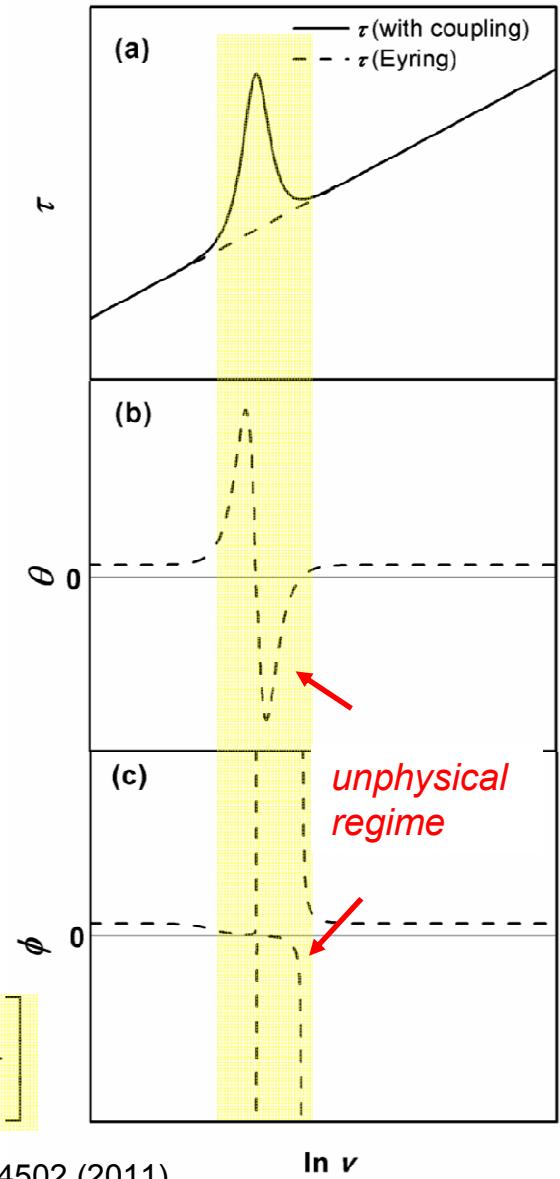
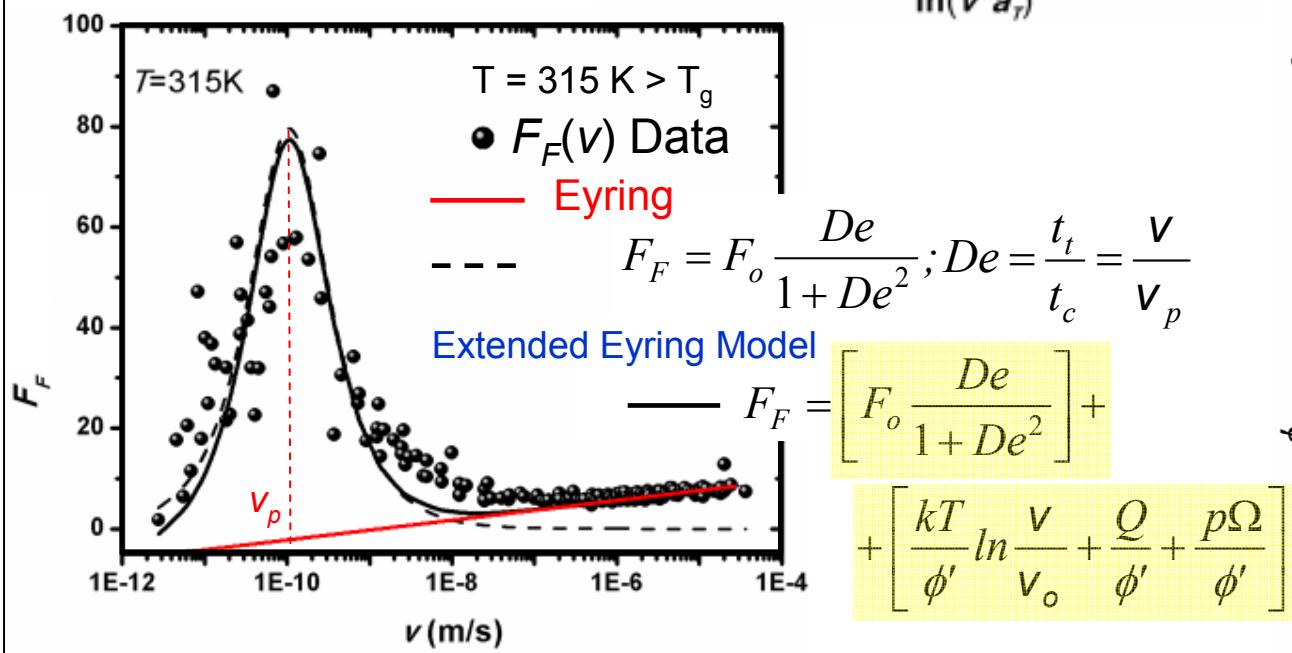
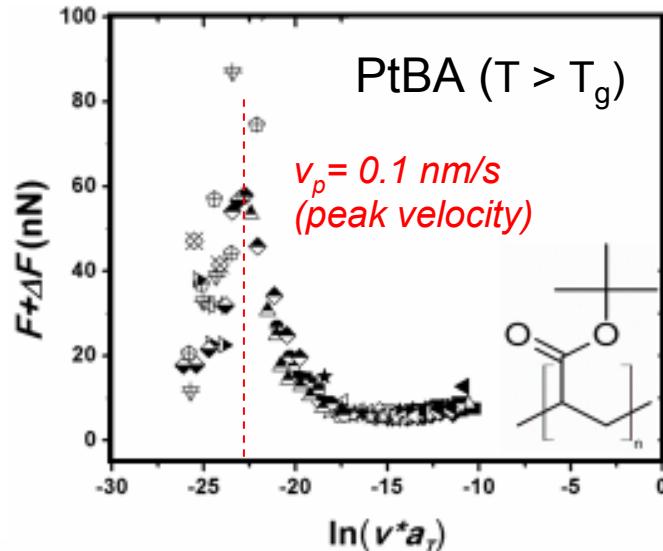
Using Intrinsic Friction Analysis (IFA)  
assuming  $Q \gg p\Omega - \tau\Phi$

→  $v_o$  could be estimated

$$v_o = \begin{cases} \sim 100 \text{ m/s for ODPA} \\ \sim 0.1 \text{ m/s for PtBA } (T < T_g) \end{cases}$$

# Other Shortcoming of Eyring Analysis

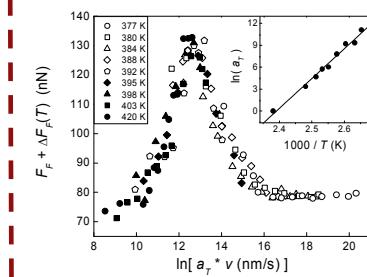
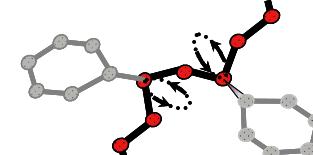
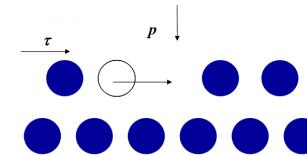
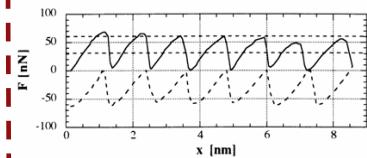
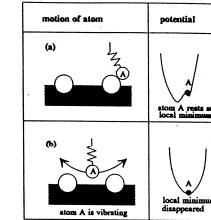
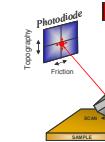
Peaks in friction-velocity curves lead to unphysical behavior of the activation volumes. Reason: Eyring analysis lacks intrinsic relaxation rates.





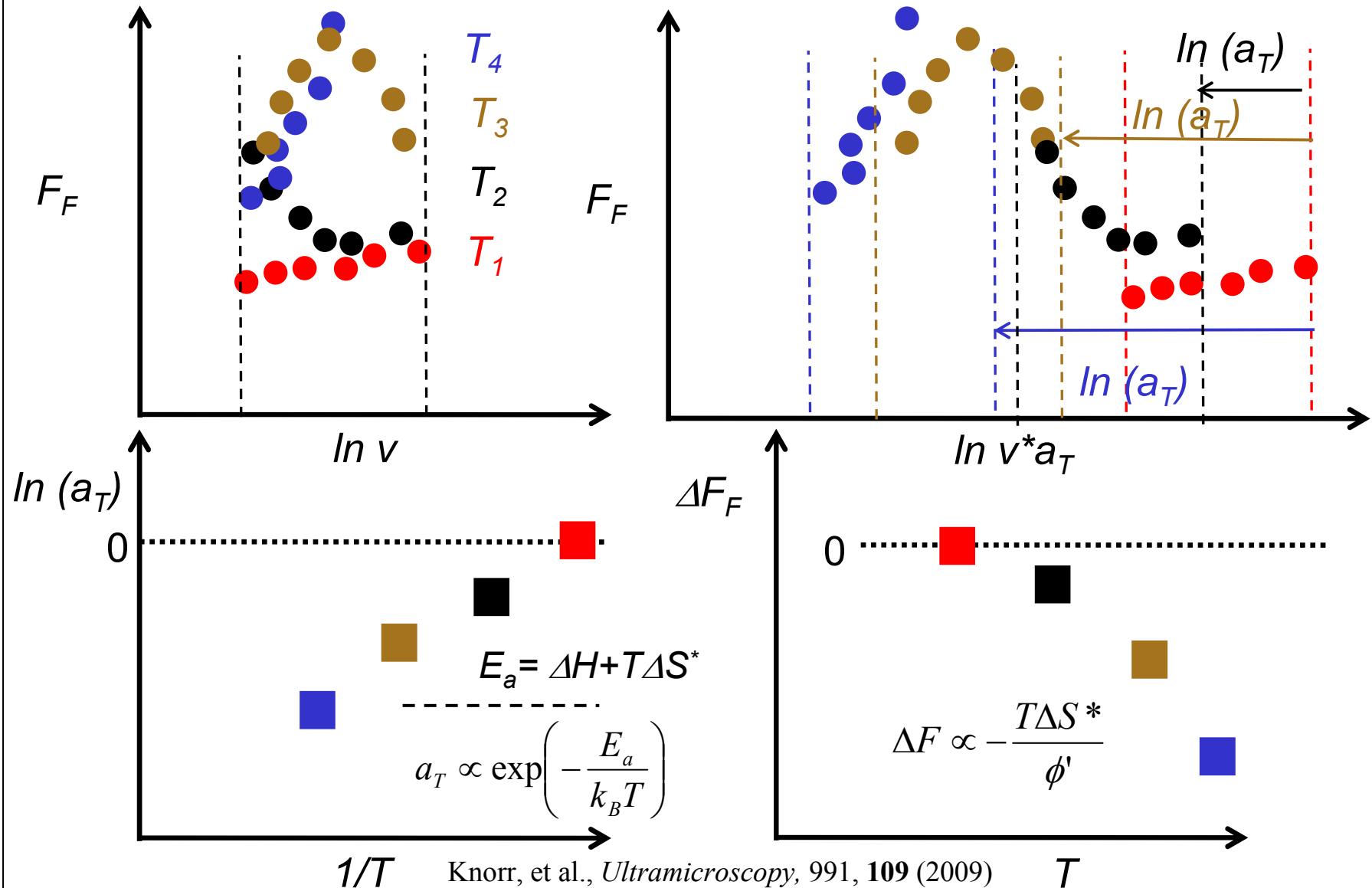
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# Time-Temperature Superposition - Intrinsic Friction Analysis (IFA)

*Shift Data to form Master Curve:  $T_1 = T_R$*

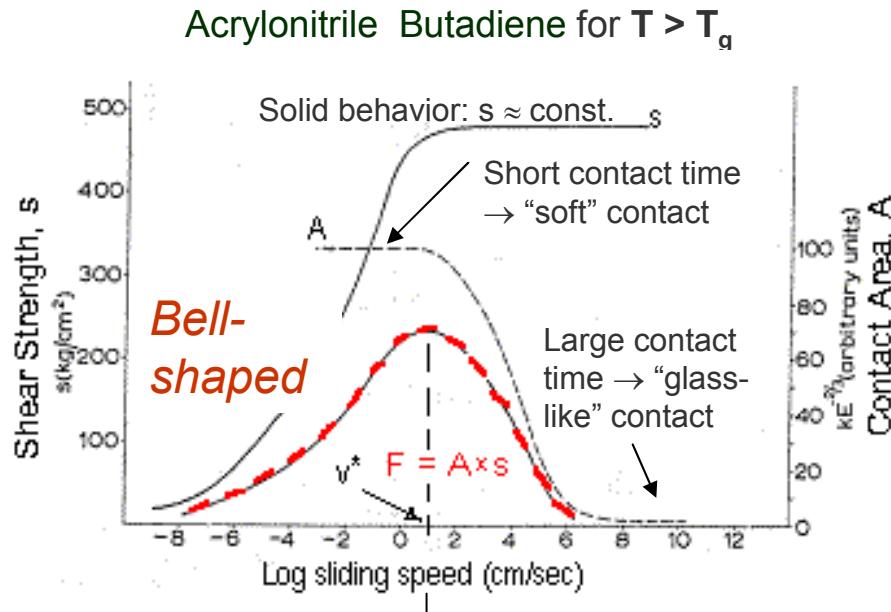


## Rubber Friction

# Adhesive-Viscoelastic Concept of Friction

Spherical slider on amorphous polymer rubber melt

(Ludema and Tabor, Wear 9, 329 (1966))



**Adhesive model:**  $F = A \times s$   
 $A$  ... contact area,  $A \propto E^{2/3}$   
 $s$  ... shear strength,  
(a high frequency process in thin film)  
 $F$  ... Friction

$v^*/v_c \sim 5-10$  nm (molecular segment)  
 $v_c$  frequency corresponding to visco-elastic loss peak.

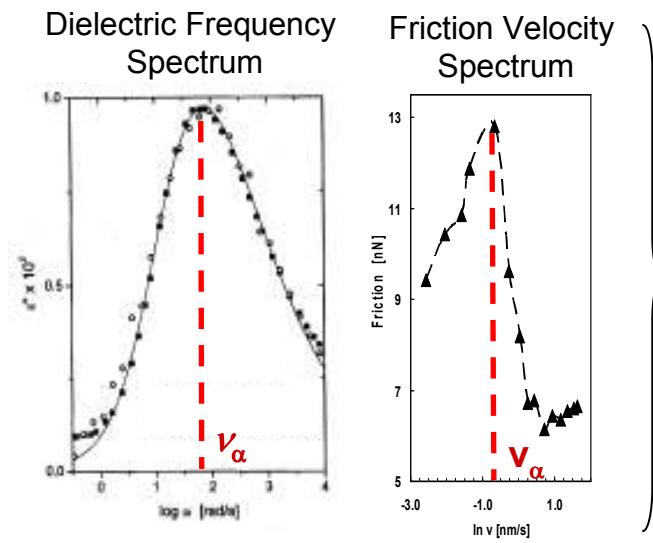
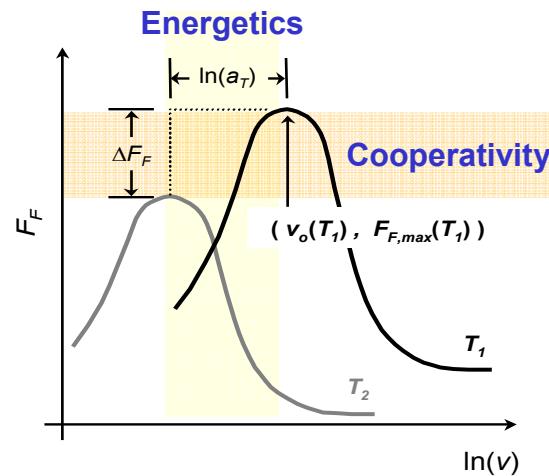
Conclusion of Ludema and Tabor, (also K.A. Grosch., Proc. R. Soc., London (1963) 274, 21):

Rubber friction is a combination force involving surface and bulk effects. The "bulk effects" involve chain segmental slips during the sliding process.

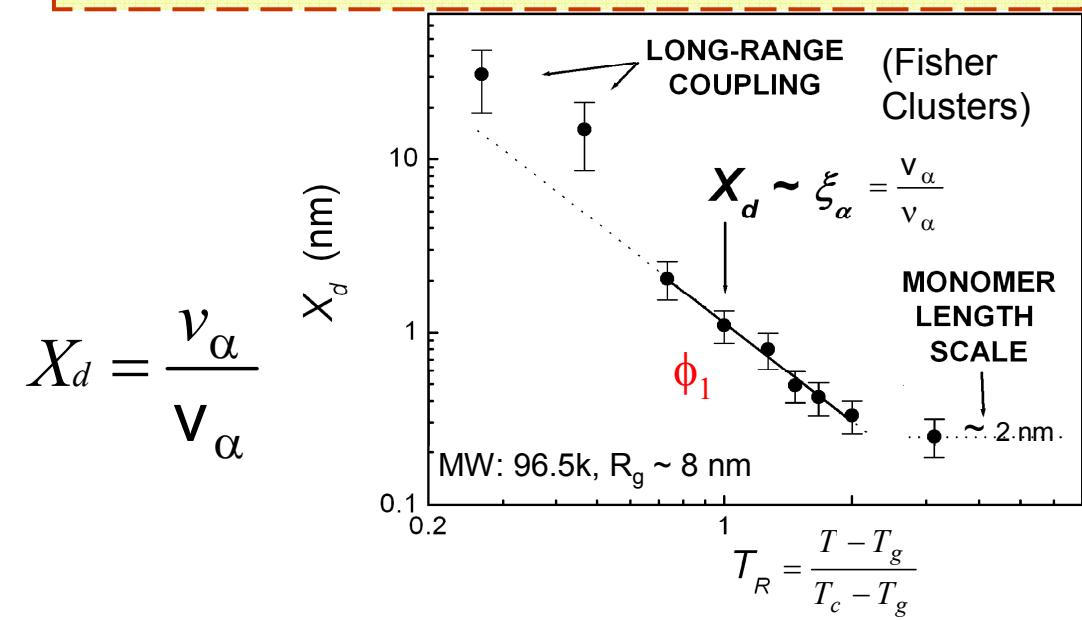
-> *Molecular Deformation Concept (Intrinsic Friction Concept)*

# Nanoscopic Analysis of the Glass Forming Process

## Intrinsic Friction Analysis (IFM)



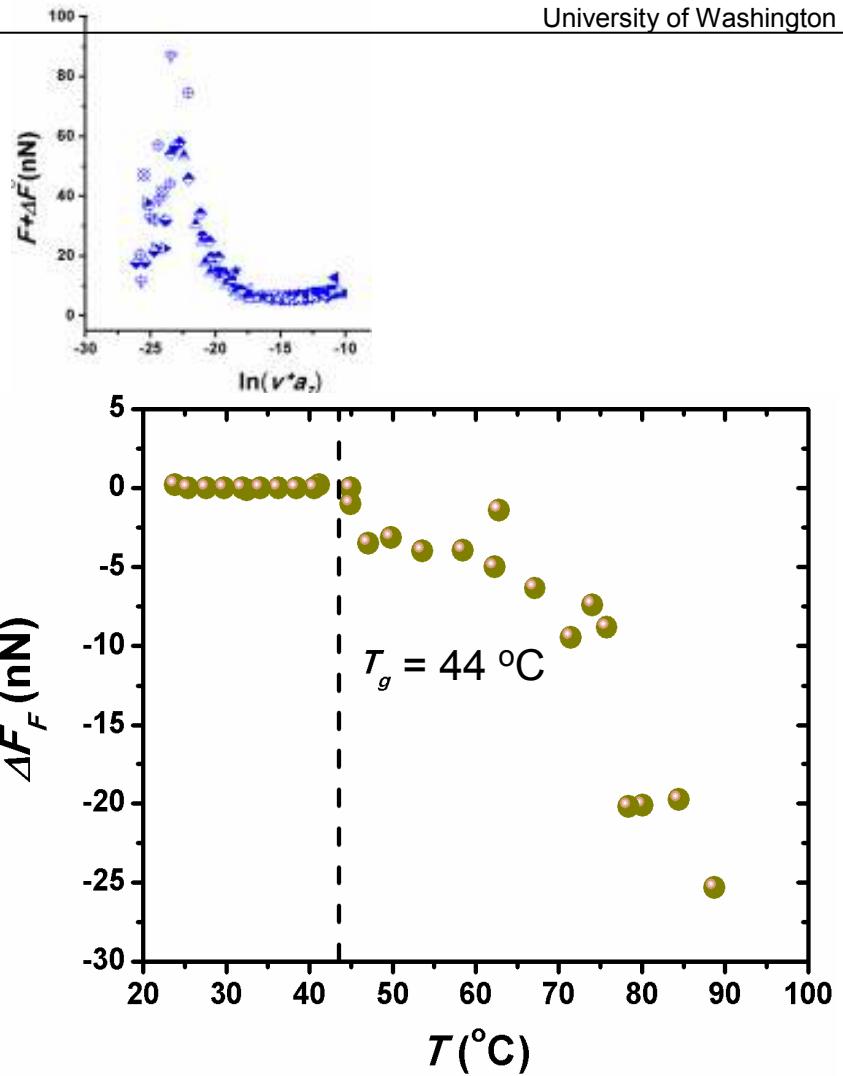
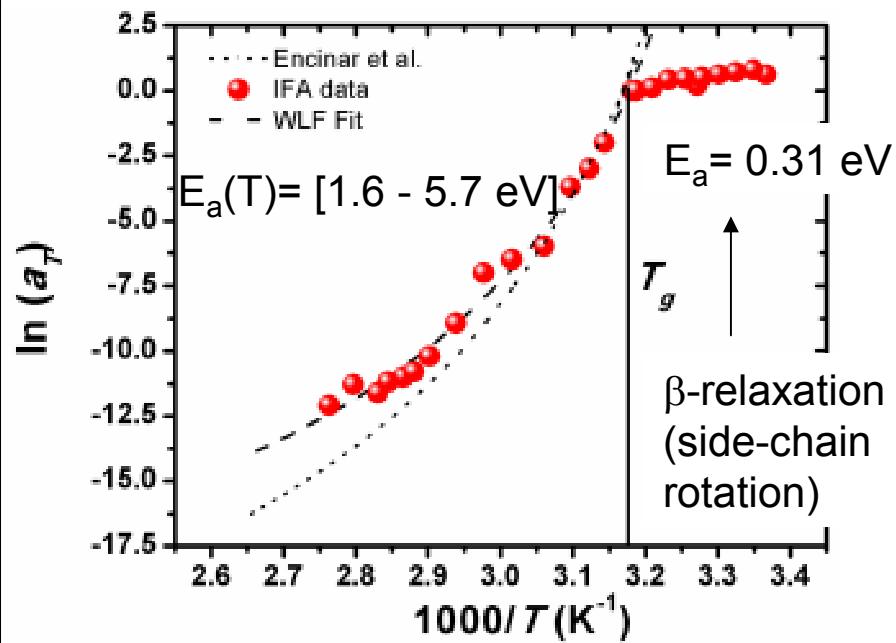
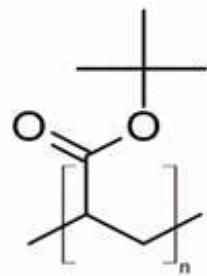
Combined with dielectric spectroscopy, the friction analysis provides the temperature resolved length scale of cooperative motion. The cooperation lengths  $X_d$  compare qualitatively well with predictions based on MD simulations and previous time-based experiments using model assumptions to deduce length scale information.



S.E. Sills, ... R.M. Overney, Chem. Phys. Lett. **123**, 134902, (2005)

# IFA on PtBA:

Poly(tert-butyl acrylate)



Williams-Landel-Ferry:

$$\log_{10} a_T = \frac{-C_1(T - T_o)}{C_2 + (T - T_o)}$$

	Encinar et al.	This work
$T_o (\text{K})$	315.4	314.4
$C_1$	10.8	10
$C_2$	45.3	40.2

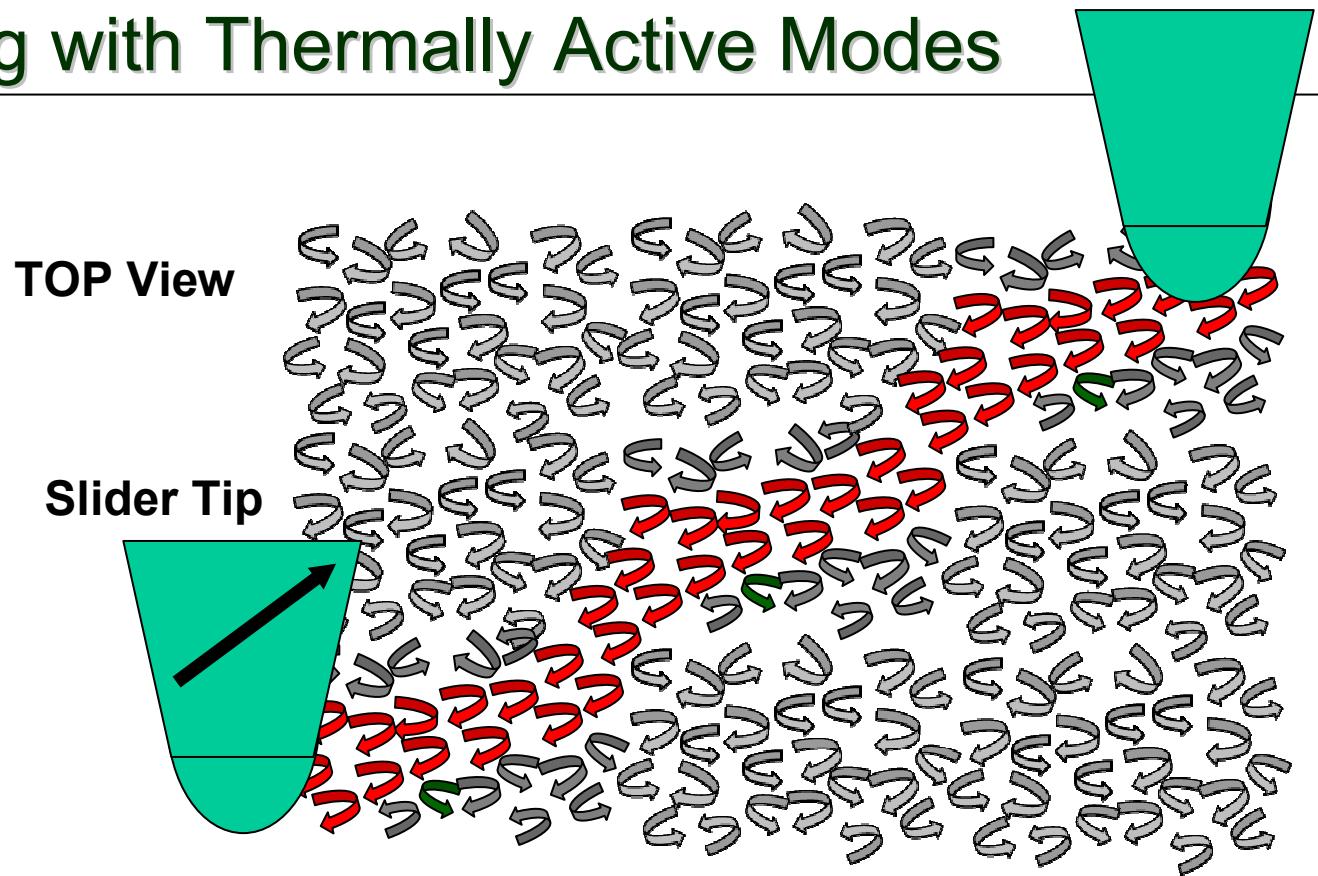
# IFA and Eyring Analysis

IFA and Eyring Parameters	ODPA (T=297K)	PtBA	
		$T = 315\text{K} < T_g$	$T > T_g$
$\Delta H^*$ kJ/mol	48±5	35±4	54-75
$T \Delta S^*$ , kJ/mol	~0	~0	100 – 490
$E_a = \Delta H + T \Delta S$ , kJ/mol	48±5	35±4	~150 – 550
$v_o$ , m/s (characteristic velocity)	~100	~0.1	-
$v_p$ , m/s (peak velocity at $T \approx T_g$ )	-	-	0.1 nm/s
$Q$ , kJ/mol (eV)	46-48 (0.48-0.50)	35-43 (0.36-0.45)	-
$E^* = Q + p\Omega - \tau\phi$ , kJ/mol (eV)	46±6 (0.47±0.06)	30±3 (0.31)	-
$\zeta$ stress ratio	51-56	7.8	-

→  $E_a \approx Q$  ... (enthalpic) activation barrier

$E^*$  ... effective barrier (contains also stress effects)

# Coupling with Thermally Active Modes



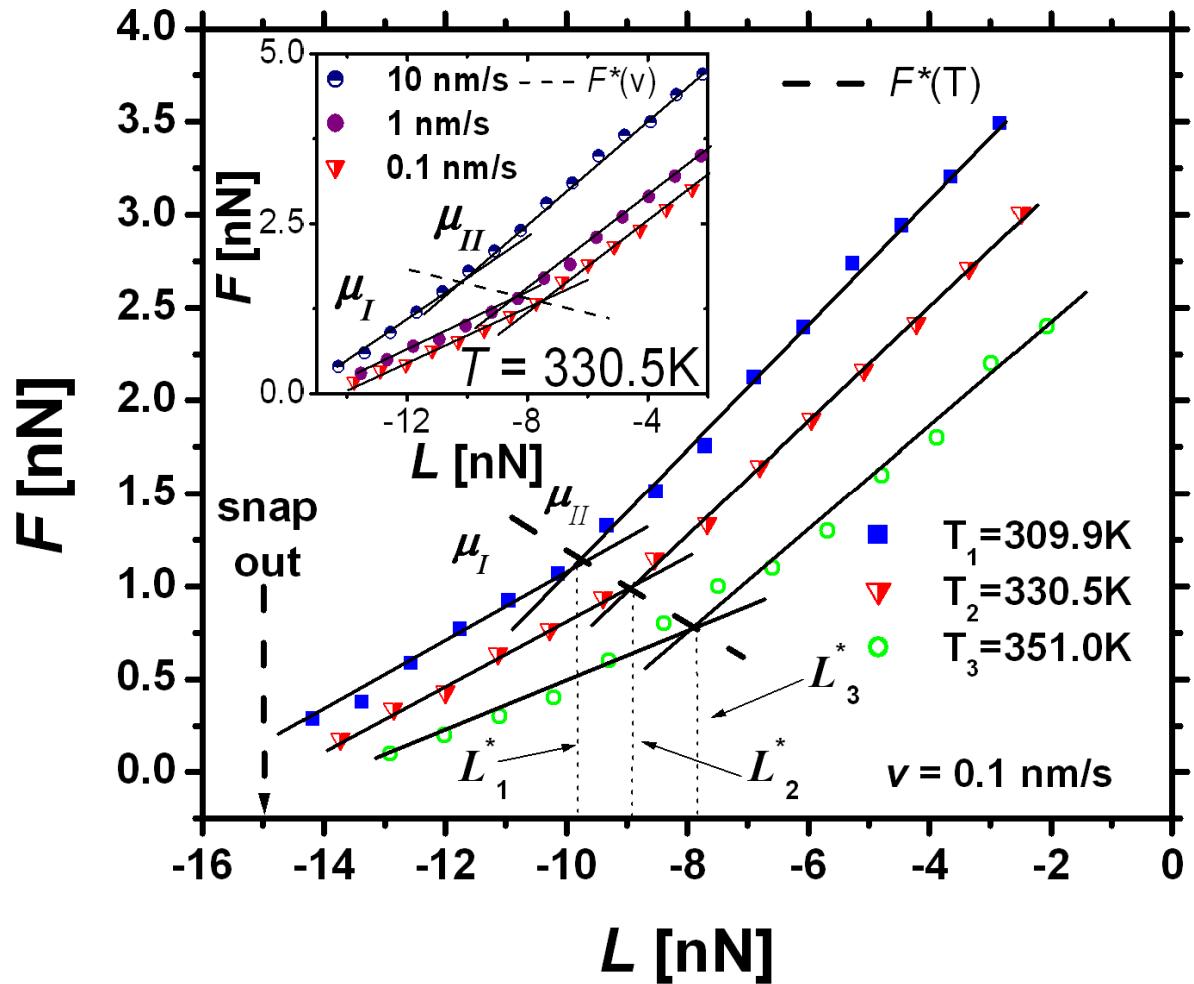
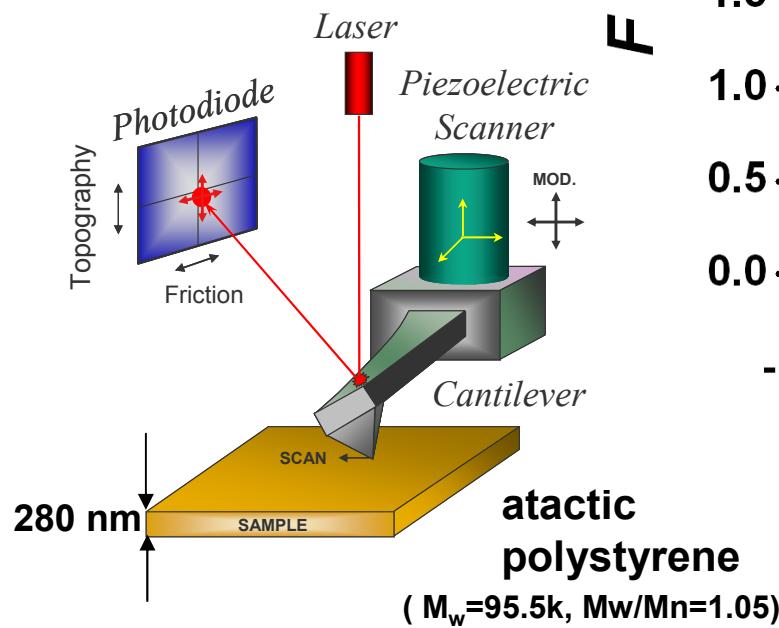
Slider 1D motion couples with thermally available mode(s) in sample  
→ Energy Dissipative Process



# Frictional Dissipation: Load Distinctive Modes

Material:  
Atactic polystyrene (PS)  
( $M_w = 95.5\text{k}$ ,  $M_w/M_n = 1.05$ )

Lateral Force  
Microscopy

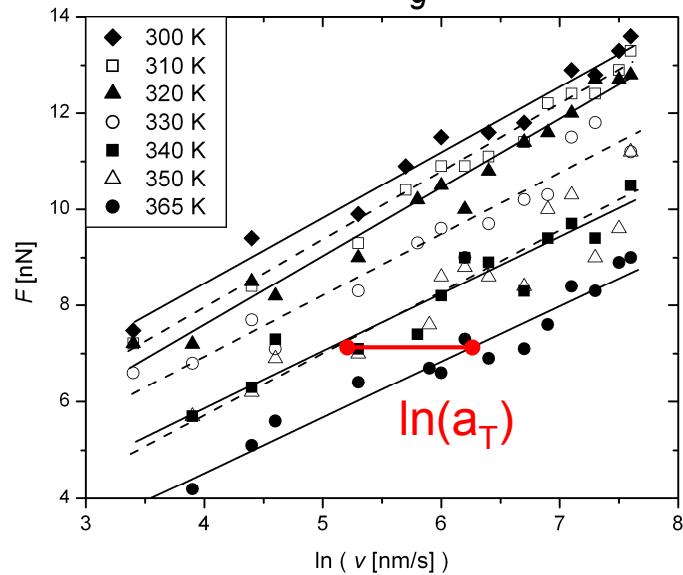


What is the origin for the kink in  
 $F(L)$  isotherms of PS at  $L = L^*$ ?

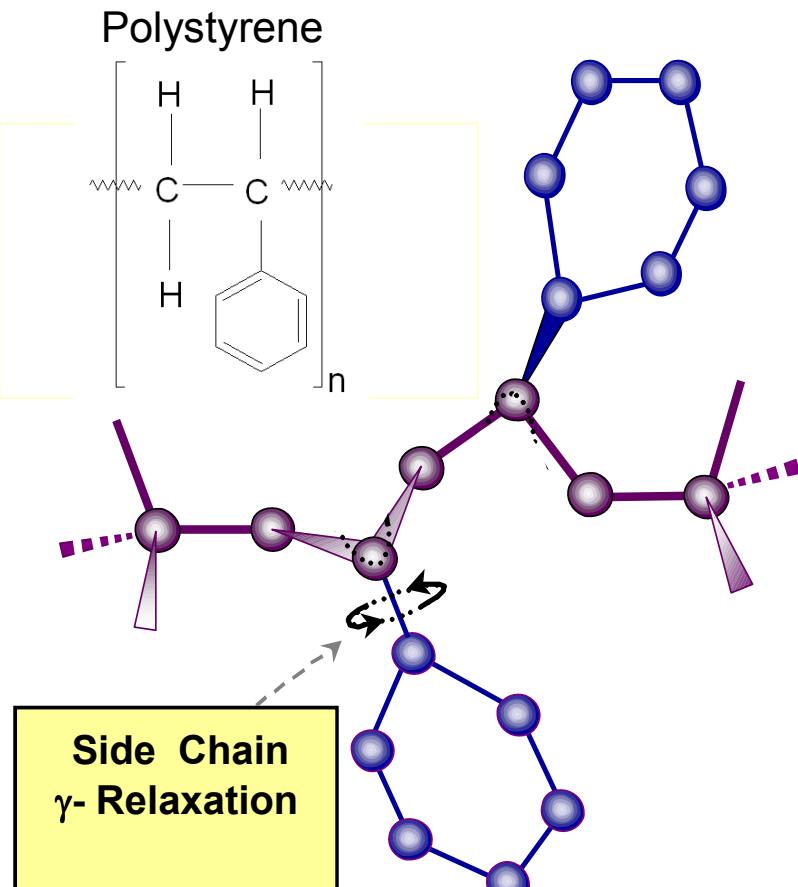
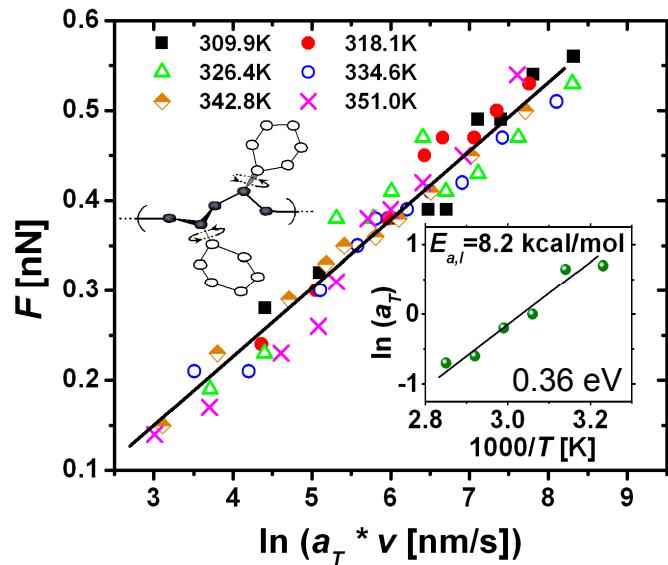


# Superposition Principle: Intrinsic Friction Analysis (IFA)

$$L < L^* \quad (T < T_g)$$



S. Sills and R.M. Overney, (2003), *Phys. Rev. Lett.* 91(9), 095501, 2003.

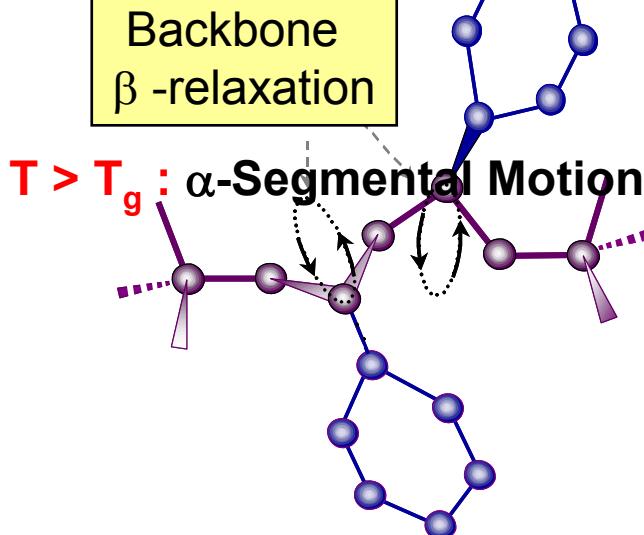
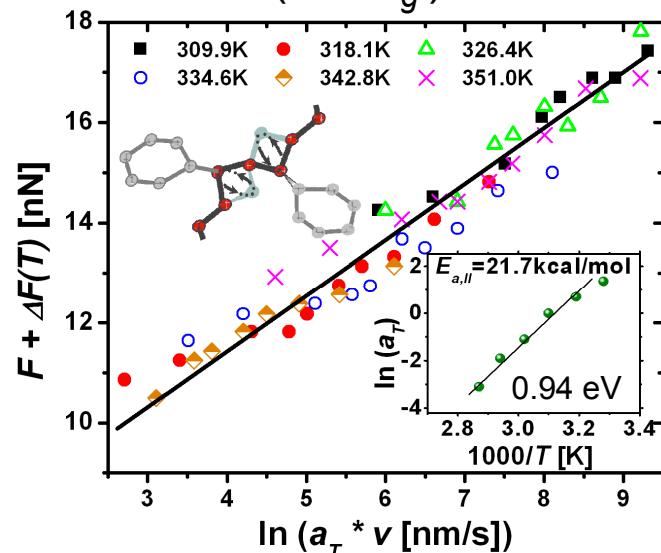


Knorr, Gray and Overney, *J. Chem. Phys.*, **129**, 074504 (2008).



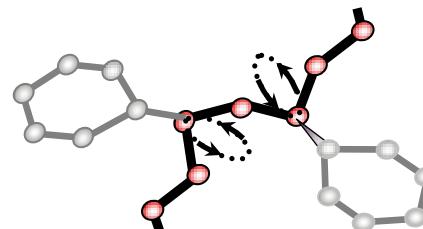
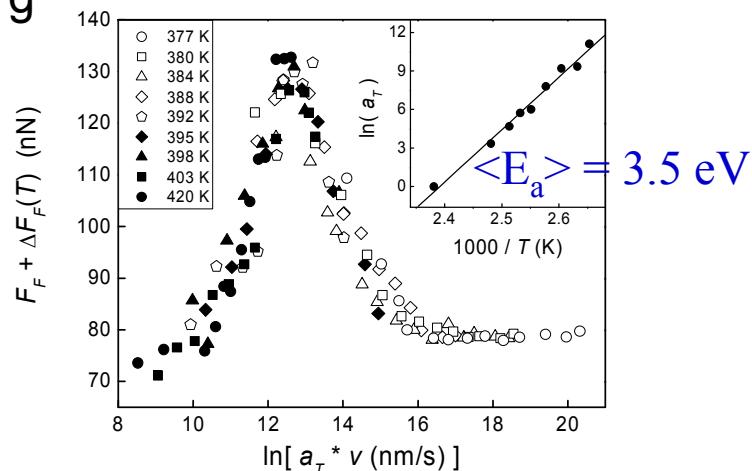
# Superposition Principle: Intrinsic Friction Analysis (IFA)

$L > L^* (T < T_g)$



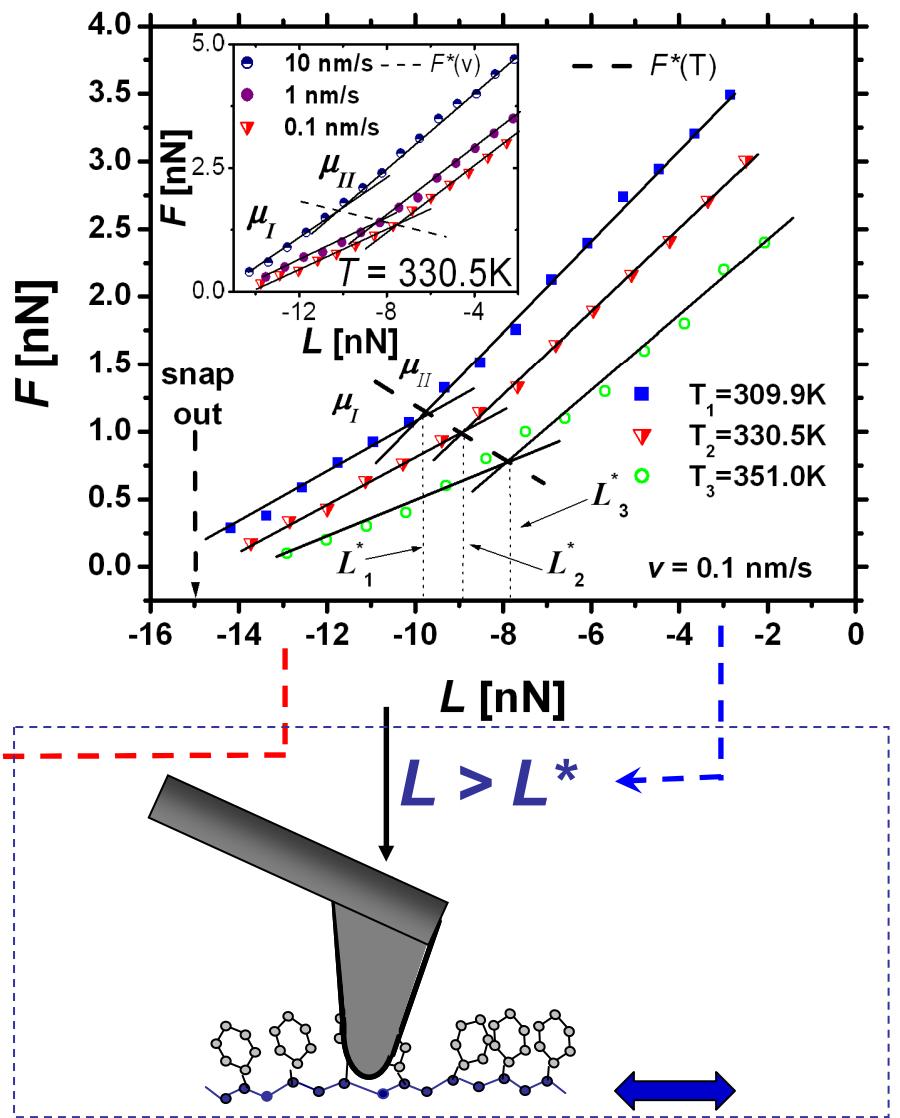
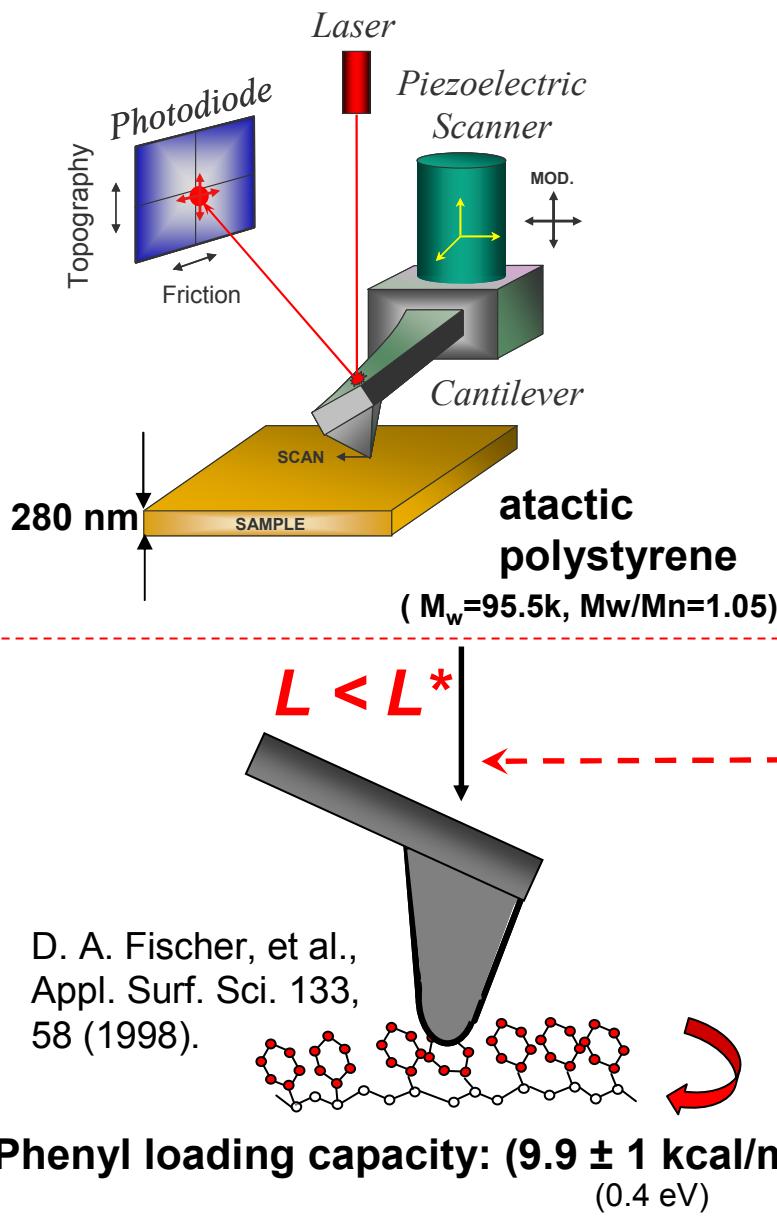
Knorr, Gray and Overney, *J. Chem. Phys.*, **129**, 074504 (2008).

Above  $T_g$



S.E. Sills, T. Gray,  
R.M. Overney,  
*Chem. Phys. Lett.*  
**123**, 134902,  
(2005).

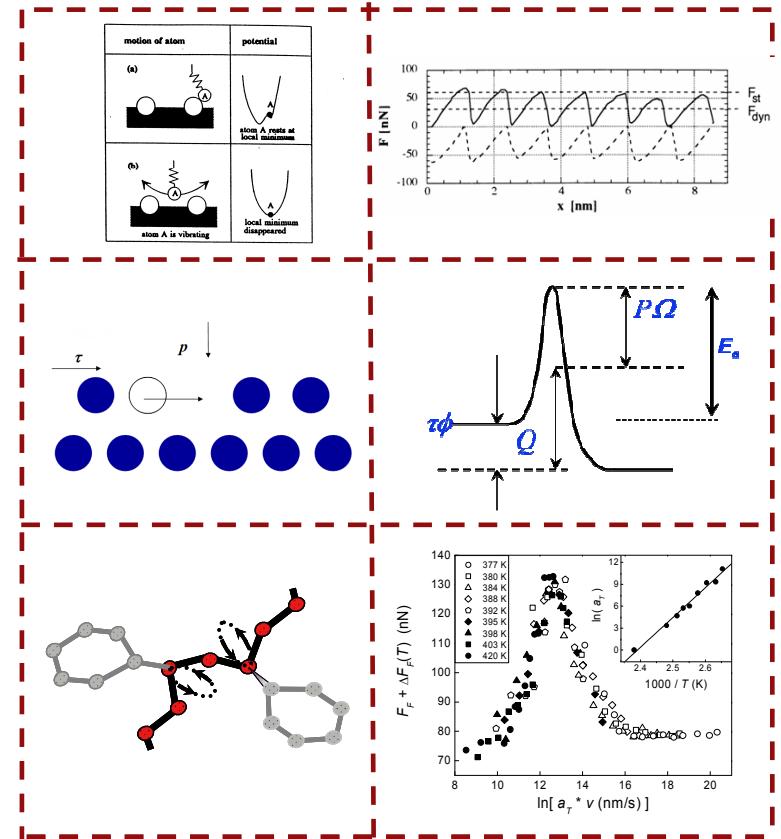
# Tribology: Molecular Dissipation Mechanisms





# Summary

- Process Descriptive Analysis of Friction  
→ Stick Slip
- Friction as a Simple Activated Process  
→ Eyring Analysis
- Friction and Thermal Mode Coupling (Material specific energy)  
→ Time Temperature Superposition Analysis





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